

Application Data Sheet

Application Information

Application Type::	Regular
Subject Matter::	Utility
Title::	Reconfigurable Chip Level Equalizer Architecture
Attorney Docket Number::	TI-35731 (1962-06700)
Suggested Drawing Figure::	1
Total Drawing Sheets::	13
Small Entity?::	No

Applicant Information

Applicant Authority type::	Inventor
Primary Citizenship	
Country::	Mexico
Status::	Full Capacity
Given Name::	Antonio F.
Family Name::	Mondragon-Torres
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State or Province of Residence::	Texas
Country of Residence::	US
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City of mailing address::	Murphy
State or Province of mailing address::	Texas
Country of mailing address::	US
Postal or Zip Code of mailing address::	75094
Applicant Authority type::	Inventor
Primary Citizenship	

Country:: US
Status:: Full Capacity
Given Name:: Steven P.
Family Name:: Pekarich
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State or Province of Residence:: Texas
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City of mailing address:: Rowlett
State or Province of
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Country of mailing
address:: US
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Applicant Authority type:: Inventor
Primary Citizenship
Country:: US
Status:: Full Capacity
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Family Name:: Schmidl
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State or Province of Residence:: Texas
Country of Residence:: US
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City of mailing address:: Dallas
State or Province of
mailing address:: Texas
Country of mailing
address:: US
Postal or Zip Code of
mailing address:: 75024

Applicant Authority type:: Inventor

Primary Citizenship Country:: Republic Of Korea
Status:: Full Capacity
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State or Province of Residence:: CA
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State or Province of
mailing address:: CA
Country of mailing address:: US
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mailing address:: 92131

Applicant Authority type:: Inventor
Primary Citizenship
Country:: Greece
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address:: US
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Applicant Authority type:: Inventor
Primary Citizenship

Country:: US
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State or Province of
mailing address:: Texas
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Applicant Authority type:: Inventor
Primary Citizenship
Country:: Indonesia
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Given Name:: Eko N.
Family Name:: Onggosanusi
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State or Province of Residence:: Texas
Country of Residence:: US
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State or Province of
mailing address:: Texas
Country of mailing
address:: US
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Correspondence Information

Correspondence Customer Number:: 23494

Representative Information

Representative Customer Number:: 23494

DOMESTIC PRIORITY INFORMATION

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Provisional of	60/435,529	12/20/02

Assignee Information

Assignee name:: Texas Instruments Incorporated
Street of mailing address:: P.O. Box 655474, MS 3999
City of mailing address:: Dallas
State or Province of
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